Multi Line AOI THT AOI system for THT PCBAs



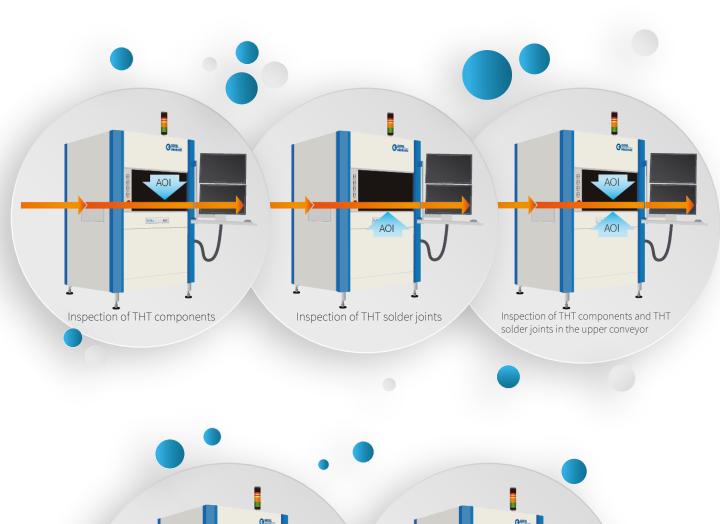
- \cdot Inspection of THT components, THT solder joints and SMD components
- \cdot double-sided inspection of THT PCBAs in the upper or lower transport module, with or without carrier
- · fully automatic AOI test program generation with MagicClick in a few minutes
- \cdot flexible data interfaces for line communication and for MES and traceability

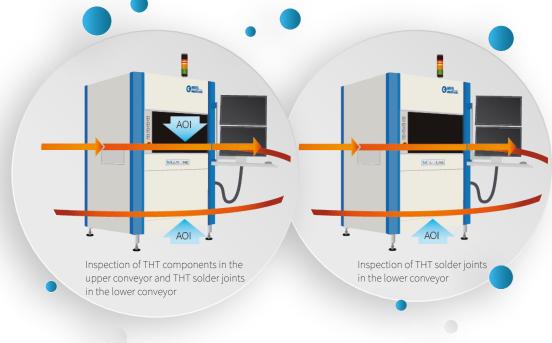




Camera modules			
	2D AOI module	2D AOI module with angled view	3D AOI module
image capturing	orthogonal camera module with telecentric optics	orthogonal camera module with telecentric optics and 4 or 8 angled view camera modules	3D/2D camera module with orthogonal camera, telecentric optics and 3D image capturing sensors
resolution per pixel	25 μm	25 µm (orthogonal) 35 µm (angled view)	15 μm
max. inspection height	up to 50 mm	up to 50 mm	35 mm
component clearance	up to 140 mm	up to 140 mm	40 mm (optionally 50 mm or 60 mm)
can be used in Multi line	component inspection from above	component inspection from above	solder joint and component inspection from above and below
Multi Line platform			
max. inspection area	540 mm x 450 mm		
max. carrier size	up to 620 mm x 510 mm		
max. transport weight	15 kg		
energy requirement	230 VAC / 2 kVA, compressed air 6 bar, consumption < 20 l/h		
transport system	conveyor belt for PCBAs with or without carriers		
transport direction	left-right, right-left, left-left, right-right		
inline interface	SMEMA, HERMES, Siemens, Sensor		
dimensions (w x d x h)	1150 mm x 1300 mm x 1800 mm		
weight	approx. 800 kg		









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